

## SMD Power Inductors (with tube / also shielded)

FASTRON power inductors can withstand a wide temperature range. The inductance values range from 1.0  $\mu$ H to 10000  $\mu$ H and they are suitable for high rated currents. They have a high reliability and can be assembled by surface mount technology. Their low DC resistance keeps power losses to a minimum. They are also suitable for Filtering of supply voltages, Coupling, Decoupling, Automotive electronics and Network switching systems.

**Applications** These components are widely used in power supplies for VTR, LCD TV, notebooks, PC and DC/DC converters.

### Technical Data

L – Value (rated inductance)	Measured with Bode 100 Vector Network Analyzer or equivalent at frequency $f_L$
SRF (min) – (unshielded only)	Measured with HP 8753ES Network Analyzer or equivalent
DCR (max)	Measured at 25°C
Rated DC Current	Isat max. current based on inductivity drop of 10% (PISG, PISL, PISM, PISMHV, PISP, PISPHV, PISN, PISNHV, PISR, PIST, PISTHV, PISA4119 & PIHV4119) related to the unloaded inductivity.  I $\Delta$ T max. and IR current based on temperature rise: determined at the point where the temperature rise does not exceed 30°C (PISG) respectively 40°C (PISL, PISM, PISMHV, PISP, PISPHV, PISN, PISNHV, PISR, PIST, PISTHV, PISA4119, PIHV4119 & SPISM) above the ambient temperature of 25°C.  I rated current indicates the current when inductivity drop of 25% max related to the unloaded inductivity or when temperature raise $\Delta T=40^\circ\text{C}$ ( $T_a=20^\circ\text{C}$ ) whichever is lower (PISA2408, PISA2416, PISA2812, PISA2816, PISA4716, PISA4720 & PISA4728)
Operating Temperature	Non shielded: -40°C to +150°C (including component self-heating) Shielded and tube: -40°C to +125°C (including component self-heating)
Recommended soldering method	Reflow
Moisture Sensitivity Levels (MSL) (Non-shielded)	MSL Level 1, indicating unlimited floor life at $\leq 30^\circ\text{C}$ / 85% relative humidity
Solderability	Using lead free solder (Sn 99.9) at $260^\circ\text{C} \pm 5^\circ\text{C}$ for $5 \pm 0.5$ seconds, min 90% solder coverage of metallization Standard: IEC 68-2-20 ( $T_a$ )
Resistance to Soldering Heat	Resistant to $260^\circ\text{C} \pm 5^\circ\text{C}$ for $10 \pm 1$ seconds Standard: IEC 68-2-20 ( $T_b$ )
Resistance to Solvent	Resistant to Isopropyl alcohol for $5 \pm 0.5$ minutes at $23^\circ\text{C} \pm 5^\circ\text{C}$ Standard: IEC 68-2-45
Climatic Test	Defined by the following standards IEC 68-2-1 for Cold test: $-55^\circ\text{C}$ for 96 hours IEC 68-2-2 for Dry heat test: $+125^\circ\text{C}$ for 96 hours IEC 60068-2-78 for Humidity test: $40^\circ\text{C}$ at RH 95% for 4 days
Thermal Shock Test (Non-shielded)	Temperature cycle : $-40^\circ\text{C}$ to $+125^\circ\text{C}$ to $-40^\circ\text{C}$ Max/Min temperature duration: 15 minutes Temperature transition duration: 5 minutes Cycles: 25 Standard: MIL-STD-202G
Adhesion of Soldered Component (Shear Test)	Components withstand a pushing force of 20N for $10 \pm 1$ seconds Standard: IEC 60068-2-21, method Ue <sub>3</sub>
Mechanical Shock	Mil-Std 202 Method 213 Condition C 3 axis, 6 times, total 18 shocks 100 G, 6 ms, half-sine
Vibration	Mil-Std 202 Method 204 20 mins at 5G 10 Hz to 2000 Hz 12 cycles each of 3 orientations

**Ordering Code** Example: PISA2408-2R9X-YY

PISA 2408 - 2R9 X - YY (Model)(Case Size) (Inductance Value)(Tolerance) (Packing Code) → PISA2408-2R9N-04

Case Sizes - 2408, 2416, 2812, 2816, 4119, 4716, 4720, 4728, G, L, M, P, N, R, T

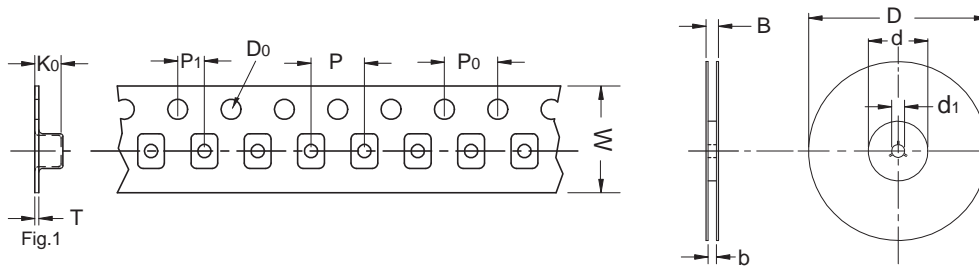
Core Type - Ferrite

Tolerances - K (10%), M (20%), N (30%)

Packing Code - 01, 04 (Taped / Reel)

## SMD Power Inductors (also shielded)

Packing Specification



drawing only schematic, see table

Type	D	D <sub>0</sub>	d	d <sub>1</sub>	B	b	W	P	P <sub>0</sub>	P <sub>1</sub>	K <sub>0</sub>	T
PISG	180	1.55	60	13	18.4	12.4	12	8	4	2	2.9	0.25
PISL	330	1.50	100	13	30.4	24.4	24	12	4	2	3.6	0.30
PISM / SPISM / PISMHV	330	1.50	100	13	30.4	24.4	24	12	4	2	5.4	0.40
PISP / PISPHV	330	1.50	100	13	30.4	24.4	24	16	4	2	8.5	0.50
PISN / PISNHV	330	1.50	100	13	30.4	24.4	24	16	4	2	11.6	0.50
PISR	330	1.50	100	13	38.4	32.4	32	24	4	2	7.6	0.40
PIST / PISTHV	330	1.50	100	13	38.4	32.4	32	24	4	2	12.5	0.50
PISA2408 / PISA2416	330	1.55	100	13	22.4	16.4	16	12	4	2	5.1	0.35
PISA2812	330	1.55	100	13	22.4	16.4	16	12	4	2	3.6	0.35
PISA2816	330	1.55	100	13	22.4	16.4	16	12	4	2	4.6	0.40
PISA4119 / PIHV4119	330	1.50	100	13	30.4	24.4	24	16	4	2	5.7	0.50
PISA4716	330	1.55	100	13	30.4	24.4	24	16	4	2	6.1	0.50
PISA4728 / PISA4720	330	1.55	100	13	30.4	24.4	24	16	4	2	8.1	0.40

Packing Specification

## FASTRON's Component Key Characteristics



Approved according to AEC-Q200



Approved according to AEC-Q200 with High Temperature



Suitable for High Temperature



Part is RoHS conform and Halogen free



Mechanical Shock and Vibration Proof



Designed for High Q-values



Exceptionally High Q-values



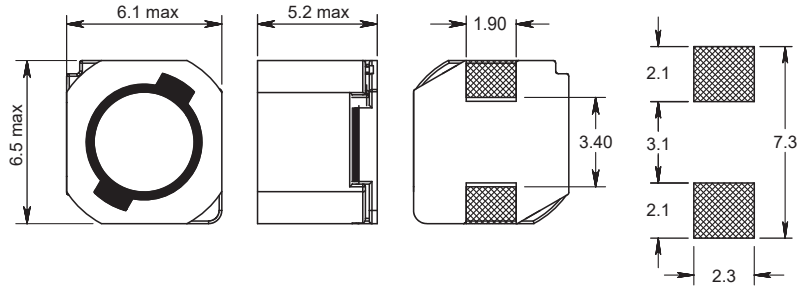
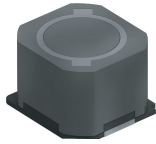
Optimized for High Currents



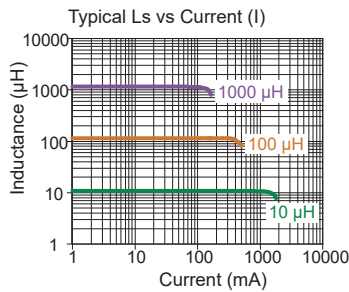
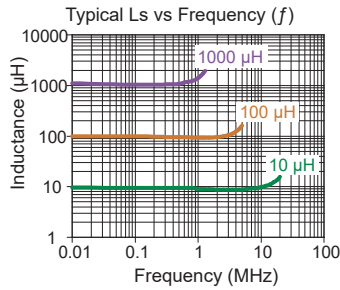
Optimized for High Voltages

# PISA 2416

Magnetically Shielded



Recommended layout for solder pads



Part No	Inductance	f <sub>L</sub>	Tol	DCR	Rated DC
	L (µH)	(kHz)	± (%)	max (Ω)	I (A)
PISA2416-4R7M-04	4.7	1	20	0.09	2.40
PISA2416-100M-04	10	1	20	0.12	1.35
PISA2416-120M-04	12	1	20	0.13	1.20
PISA2416-150M-04	15	1	20	0.18	1.10
PISA2416-180M-04	18	1	20	0.24	1.00
PISA2416-220M-04	22	1	20	0.27	0.91
PISA2416-270M-04	27	1	20	0.3	0.82
PISA2416-330M-04	33	1	20	0.33	0.75
PISA2416-390M-04	39	1	20	0.37	0.69
PISA2416-470M-04	47	1	20	0.52	0.62
PISA2416-560M-04	56	1	20	0.56	0.58
PISA2416-680M-04	68	1	20	0.63	0.52
PISA2416-820M-04	82	1	20	0.71	0.47
PISA2416-101M-04	100	1	20	1.03	0.43
PISA2416-121M-04	120	1	20	1.15	0.39
PISA2416-151M-04	150	1	20	1.68	0.35
PISA2416-181M-04	180	1	20	1.87	0.32
PISA2416-221M-04	220	1	20	2.08	0.29
PISA2416-271M-04	270	1	20	2.37	0.26
PISA2416-331M-04	330	1	20	2.67	0.23
PISA2416-391M-04	390	1	20	2.94	0.22
PISA2416-471M-04	470	1	20	3.93	0.2
PISA2416-561M-04	560	1	20	5.43	0.18
PISA2416-681M-04	680	1	20	7.32	0.17
PISA2416-821M-04	820	1	20	8.24	0.15
PISA2416-102M-04	1000	1	20	9.26	0.14

**Core Material:** Ferrite  
**Base Material:** Plastic

Revision date: 25 Jul 2018

**SPQ:** Taped / Reel 1000 [-04]

**Remarks:** - Additional gluing to PCB board is recommended.  
- I - see description in Inductors Technical Data.